

# IRFF110

#### PD-90423E

Repetitive Avalanche and dv/dt Rated Power MOSFET Thru-Hole (TO-205AF / TO-39) 100V, 3.5A, N-channel

#### Features

- Repetitive avalanche ratings
- Dynamic dv/dt rating
- Hermetically sealed
- Simple drive requirements
- ESD rating: Class 1A per MIL-STD-750, Method 1020

### **Potential Applications**

- DC-DC converter
- Motor drives

### **Product Validation**

Qualified according to MIL-PRF-19500 for space applications

### Description

HEXFET POWER MOSFET technology is the key to IR HiRel's advanced line of power MOSFET transistors. The efficient geometry and unique processing of this latest "State of the Art" design achieves: very low on-state resistance combined with high trans conductance; superior reverse energy and diode recovery dv/dt capability. The HEXFET transistors also feature all of the well-established advantages of MOSFETs such as voltage control, very fast switching and temperature stability of the electrical parameters. They are well suited for applications such as switching power supplies, motor controls, inverters, choppers, audio amplifiers and high energy pulse circuits.

#### **Ordering Information**

#### Table 1 Ordering options

Part number	Package	Screening Level
IRFF110	TO-205AF / TO-39	COTS
2N6782	TO-205AF / TO-39	COTS
JANTX2N6782	TO-205AF / TO-39	JANTX
JANTXV2N6782	TO-205AF / TO-39	JANTXV



**Product Summary** 

 $\mathbf{R}_{\text{DS(on),max}}$ : 0.6 $\Omega$ 

**Q**<sub>G, max</sub>: 8.1nC

**BV**<sub>DSS</sub>: 100V

I<sub>D</sub>: 3.5A



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# 1 Absolute Maximum Ratings

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Table 2	Absolute Maximum Ratings
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Symbol	Parameter	Value	Unit
$I_{D1} @ V_{GS} = 10V, T_C = 25^{\circ}C$	Continuous Drain Current	3.5	А
$I_{D2} @ V_{GS} = 10V, T_{C} = 100^{\circ}C$	Continuous Drain Current	2.25	А
I <sub>DM</sub> @ T <sub>c</sub> = 25°C	Pulsed Drain Current <sup>1</sup>	14	А
$P_{D} @ T_{C} = 25^{\circ}C$	Maximum Power Dissipation	15	W
	Linear Derating Factor	0.12	W/°C
V <sub>GS</sub>	Gate-to-Source Voltage	± 20	V
E <sub>AS</sub>	Single Pulse Avalanche Energy <sup>2</sup>	68	mJ
I <sub>AR</sub>	Avalanche Current <sup>1</sup>	3.5	А
E <sub>AR</sub>	Repetitive Avalanche Energy <sup>1</sup>	1.5	mJ
dv/dt	Peak Diode Reverse Recovery <sup>3</sup>	5.5	V/ns
TJ T <sub>STG</sub>	Operating Junction and Storage Temperature Range	-55 to +150	°C
	Lead Temperature	300 (0.063 in. (1.6mm) from case for 10s)	
	Weight	0.98 (Typical)	g

<sup>&</sup>lt;sup>1</sup> Repetitive Rating; Pulse width limited by maximum junction temperature.

 $<sup>^2</sup>$  V\_{DD} = 25V, starting T\_J = 25°C, L = 11.1mH, Peak I\_L = 3.5A

 $<sup>^3</sup>$  I\_{SD}  $\leq$  3.5A,  $di/dt \leq$  75A/µs, V\_{DD}  $\leq$ 100 V,  $T_J \leq$  150°C



**Device Characteristics** 

## 2 Device Characteristics

### 2.1 Electrical Characteristics

### Table 3 Static and Dynamic Electrical Characteristics @ T<sub>j</sub> = 25°C (Unless Otherwise Specified)

Symbol	Parameter	Min.	Тур.	Max.	Unit	Test Conditions	
BV <sub>DSS</sub>	Drain-to-Source Breakdown Voltage	100	_	_	V	V <sub>GS</sub> = 0V, I <sub>D</sub> =1.0mA	
$\Delta {\sf BV}_{\sf DSS}/\Delta {\sf T}_{\sf J}$	Breakdown Voltage Temp. Coefficient	_	0.10	_	V/°C	Reference to 25°C, I <sub>D</sub> = 1.0mA	
D	Static Drain-to-Source On-State	_	_	0.60	Ω	$V_{GS}$ =10 V, $I_{D2}$ = 2.25A <sup>1</sup>	
R <sub>DS(on)</sub>	Resistance	_	_	0.61	52	$V_{GS}$ = 10V, $I_{D2}$ = 3.5A <sup>1</sup>	
V <sub>GS(th)</sub>	Gate Threshold Voltage	2.0	—	4.0	V	$V_{DS} = V_{GS}$ , $I_{D} = 250 \mu A$	
Gfs	Forward Transconductance	0.8		_	S	$V_{DS} = 15V, I_{D2} = 2.25A^{1}$	
		_	_	25	•	$V_{DS} = 80V, V_{GS} = 0V$	
DSS	Zero Gate Voltage Drain Current	_	_	250	μA	$V_{DS} = 80V, V_{GS} = 0V, T_{J} = 125^{\circ}C$	
	Gate-to-Source Leakage Forward	_	_	100		$V_{GS} = 20V$	
GSS	Gate-to-Source Leakage Reverse	-	_	-100	nA	$V_{GS} = -20V$	
Q <sub>G</sub>	Total Gate Charge		_	8.1		$I_{D1} = 3.5A$ $V_{DS} = 50V$	
Q <sub>GS</sub>	Gate-to-Source Charge		_	1.7	nC		
$Q_{GD}$	Gate-to-Drain ('Miller') Charge		_	4.5		$V_{GS} = 10V$	
t <sub>d(on)</sub>	Turn-On Delay Time	-	_	15		I <sub>D1</sub> = 3.5A **	
t <sub>r</sub>	Rise Time	-	_	25		$V_{DD} = 50V$	
t <sub>d(off)</sub>	Turn-Off Delay Time	-	_	25	ns	$R_{G} = 7.5\Omega$	
t <sub>f</sub>	Fall Time	_	_	20		$V_{GS} = 10V$	
L <sub>s</sub> +L <sub>D</sub>	Total Inductance	_	7.0	_	nH	Measured from Drain lead (6mm / 0.25 in from package) to Source lead (6mm/ 0.25 in from package) with Source wire internally bonded from Source pin to Drain pin	
C <sub>iss</sub>	Input Capacitance	_	180	—		V <sub>GS</sub> = 0V	
C <sub>oss</sub>	Output Capacitance	-	82	—	рF	V <sub>DS</sub> = 25V	
C <sub>rss</sub>	Reverse Transfer Capacitance	_	15	—		<i>f</i> = 1.0MHz	

\*\* Switching speed maximum limits are based on manufacturing test equipment and capability.

 $<sup>^1</sup>$  Pulse width  $\leq$  300  $\mu s$ ; Duty Cycle  $\leq$  2%

### 2.2 Source-Drain Diode Ratings and Characteristics

### Table 4Source-Drain Diode Characteristics

Symbol	Parameter	Min.	Тур.	Max.	Unit	Test Conditions	
ls	Continuous Source Current (Body Diode)		_	3.5	А		
I <sub>SM</sub>	Pulsed Source Current (Body Diode) <sup>1</sup>	_	_	14	А		
$V_{SD}$	Diode Forward Voltage	-	_	1.5	V	$T_J = 25^{\circ}C$ , $I_S = 3.5A$ , $V_{GS} = 0V^{-2}$ $T_J = 25^{\circ}C$ , $I_F = 3.5A$ , $V_{DD} \le 50V$	
t <sub>rr</sub>	Reverse Recovery Time	-		180	ns		
Q <sub>rr</sub>	Reverse Recovery Charge	-	1.3		μC	di/dt = 100A/µs	
t <sub>on</sub>	Forward Turn-On Time		sic turn-	on time	is neglig	ible (turn-on is dominated by $L_s+L_D$ )	

### 2.3 Thermal Characteristics

#### Table 5 Thermal Resistance

Symbol	Parameter	Min.	Тур.	Max.	Unit
$R_{\theta JC}$	Junction-to-Case	_	_	8.33	°C /\\
$R_{\theta JA}$	Junction-to-Ambient (Typical socket mount)	_	_	175	°C/W

<sup>&</sup>lt;sup>1</sup> Repetitive Rating; Pulse width limited by maximum junction temperature.

 $<sup>^2</sup>$  Pulse width  $\leq$  300  $\mu$ s; Duty Cycle  $\leq$  2%

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**Electrical Characteristics Curves** 



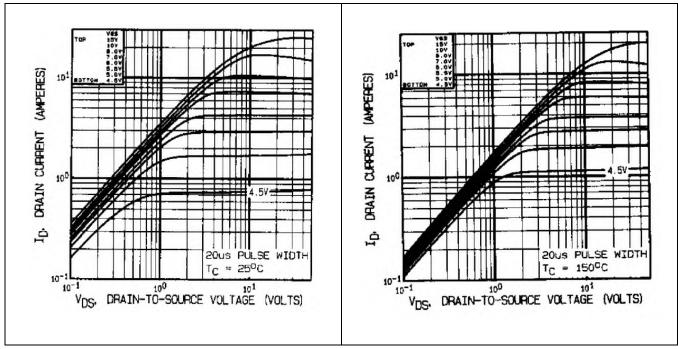
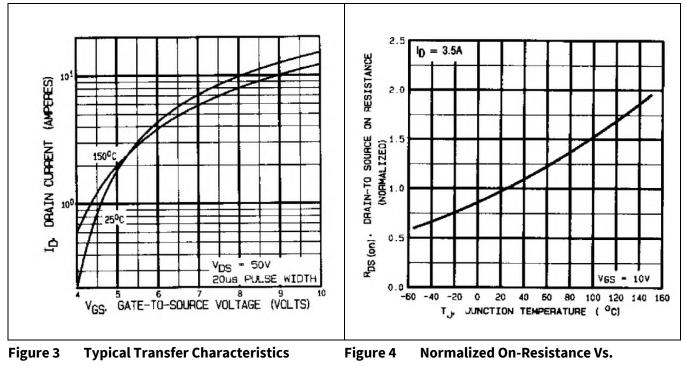


Figure 1 Typical Output Characteristics

Figure 2

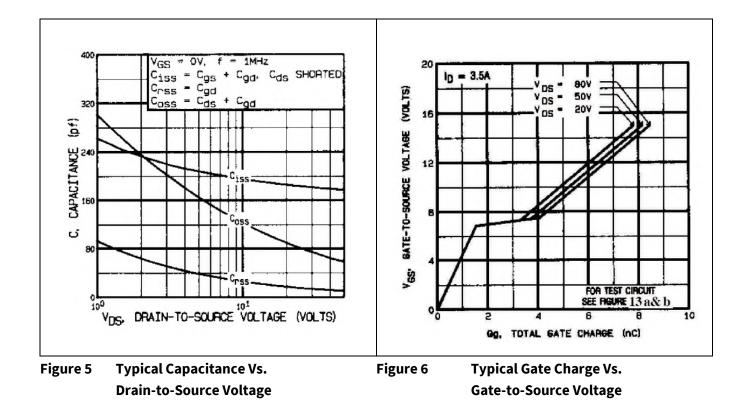
Typical Output Characteristics



Temperature



#### **Electrical Characteristics Curves**



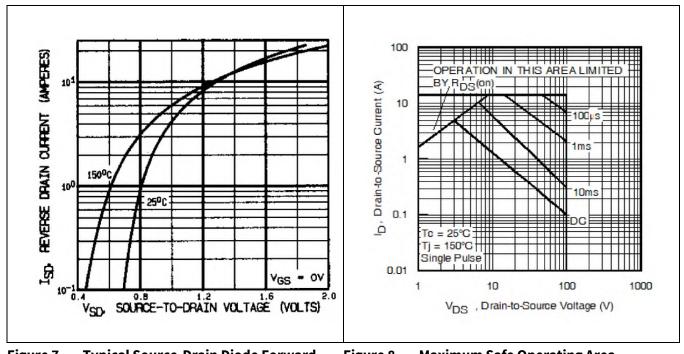
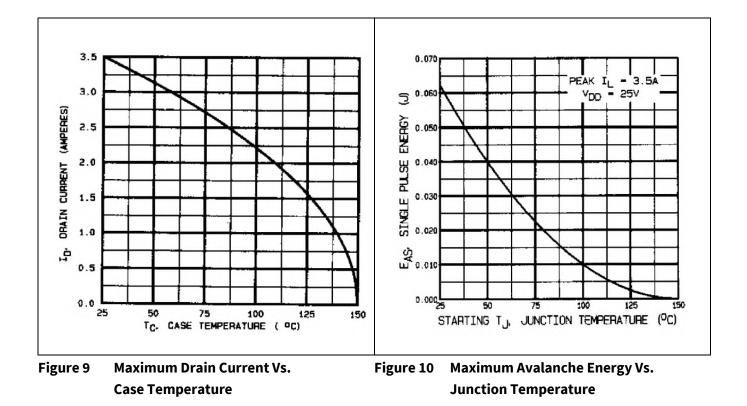


Figure 7 Typical Source-Drain Diode Forward Figure 8 Maximum Safe Operating Area Voltage



### **Electrical Characteristics Curves**



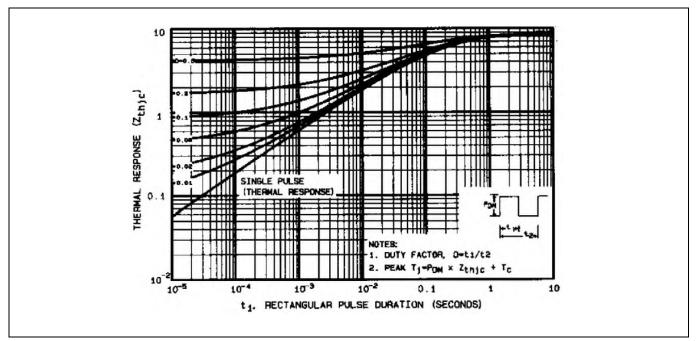


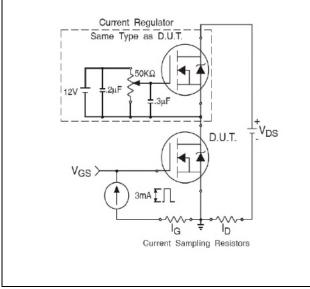
Figure 11 Maximum Effective Transient Thermal Impedance, Junction-to-Case



#### **Test Circuits**



### **Test Circuits**





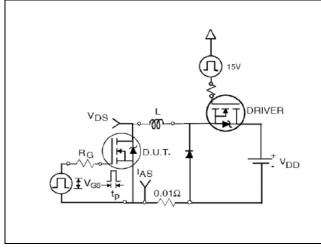
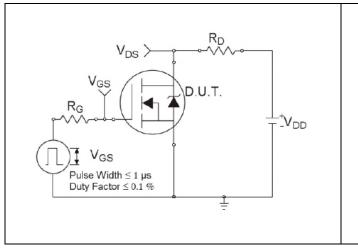
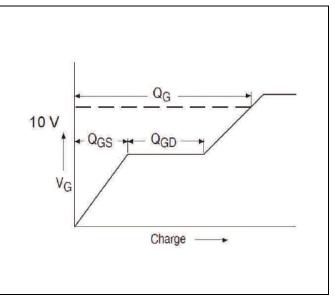
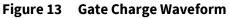


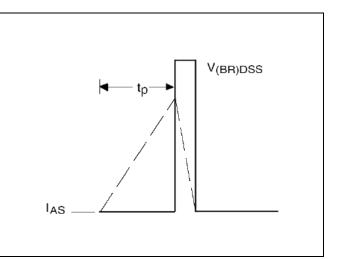
Figure 14 Unclamped Inductive Test Circuit











#### Figure 15 Unclamped Inductive Waveform

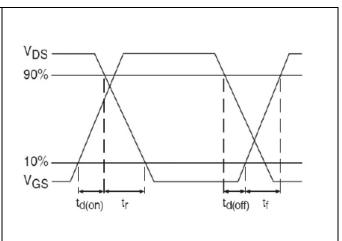


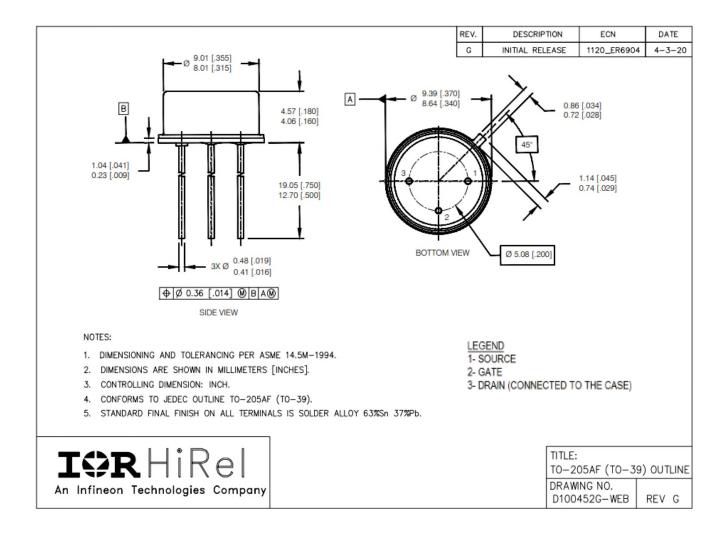
Figure 17 Switching Time Waveforms



Package Outline

# 5 Package Outline

#### Note: For the most updated package outline, please see the website: TO-205AF / TO-39





# **Revision history**

Document version	Date of release	Description of changes	
	01/26/2001	Datasheet (PD-90423C)	
Rev D	12/04/2018	Updated based on ECN-1120_06255	
Rev E	01/16/2023	Updated based on ECN-1120_09384	

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**Document reference** 

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